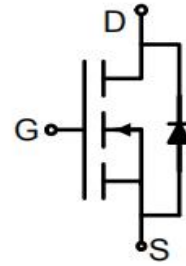




## N-Channel Enhancement Mode Power MOSFET

### Description

The MX4468 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.



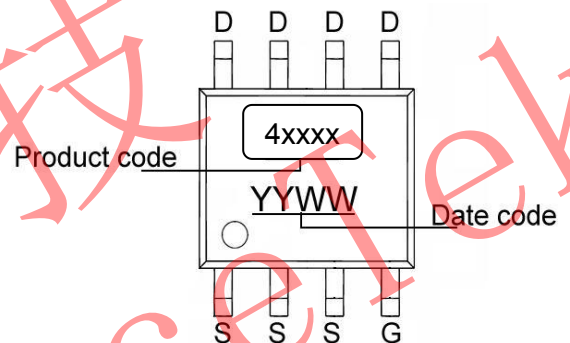
Schematic diagram

### General Features

- ◆  $V_{DS} = 30V$ ,  $I_D = 10A$
- ◆  $R_{DS(ON)}(Typ.) < 8m\Omega$  @  $V_{GS} = 10V$
- ◆  $R_{DS(ON)}(Typ.) < 11m\Omega$  @  $V_{GS} = 4.5V$
- ◆ High density cell design for ultra low  $R_{DS(on)}$
- ◆ Fully characterized Avalanche voltage and current

### Application

Power switching application  
Hard Switched and High Frequency Circuits  
Uninterruptible Power Supply



Marking and pin assignment

### Absolute Maximum Ratings ( $T_A = 25^\circ C$ unless otherwise noted)

| Parameter                                        | Symbol             | Limit      | Unit       |
|--------------------------------------------------|--------------------|------------|------------|
| Drain-Source Voltage                             | $V_{DS}$           | 30         | V          |
| Gate-Source Voltage                              | $V_{GS}$           | $\pm 20$   | V          |
| Drain Current-Continuous                         | $I_D$              | 10         | A          |
| Drain Current-Continuous( $T_C = 100^\circ C$ )  | $I_D(100^\circ C)$ | 6          | A          |
| Pulsed Drain Current                             | $I_{DM}$           | 50         | A          |
| Maximum Power Dissipation                        | $P_D$              | 2.5        | W          |
| Operating Junction and Storage Temperature Range | $T_J, T_{STG}$     | -55 To 150 | $^\circ C$ |



**Electrical Characteristics** (TA=25°C unless otherwise noted)

| Parameter                          | Symbol              | Condition                                                                              | Min | Typ  | Max  | Unit |
|------------------------------------|---------------------|----------------------------------------------------------------------------------------|-----|------|------|------|
| Off Characteristics                |                     |                                                                                        |     |      |      |      |
| Drain-Source Breakdown Voltage     | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250μA                                              | 30  | 33   | -    | V    |
| Zero Gate Voltage Drain Current    | I <sub>DSS</sub>    | V <sub>DS</sub> =30V, V <sub>GS</sub> =0V                                              | -   | -    | 1    | μA   |
| Gate-Body Leakage Current          | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                                             | -   | -    | ±100 | nA   |
| On Characteristics (Note 3)        |                     |                                                                                        |     |      |      |      |
| Gate Threshold Voltage             | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA                               | 1   | 1.6  | 3    | V    |
| Drain-Source On-State Resistance   | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =10A                                              | -   | 8    | 12   | mΩ   |
|                                    |                     | V <sub>GS</sub> =4.5V, I <sub>D</sub> =5A                                              | -   | 11   | 16   |      |
| Forward Transconductance           | g <sub>FS</sub>     | V <sub>DS</sub> =5V, I <sub>D</sub> =10A                                               | 15  | -    | -    | S    |
| Dynamic Characteristics (Note4)    |                     |                                                                                        |     |      |      |      |
| Input Capacitance                  | C <sub>iss</sub>    | V <sub>DS</sub> =15V, V <sub>GS</sub> =0V,<br>F=1.0MHz                                 | -   | 1550 | -    | PF   |
| Output Capacitance                 | C <sub>oss</sub>    |                                                                                        | -   | 300  | -    | PF   |
| Reverse Transfer Capacitance       | C <sub>rss</sub>    |                                                                                        | -   | 180  | -    | PF   |
| Switching Characteristics (Note 4) |                     |                                                                                        |     |      |      |      |
| Turn-on Delay Time                 | t <sub>d(on)</sub>  | V <sub>DD</sub> =25V, I <sub>D</sub> =1A<br>V <sub>GS</sub> =10V, R <sub>GEN</sub> =6Ω | -   | 30   | -    | nS   |
| Turn-on Rise Time                  | t <sub>r</sub>      |                                                                                        | -   | 20   | -    | nS   |
| Turn-Off Delay Time                | t <sub>d(off)</sub> |                                                                                        | -   | 100  | -    | nS   |
| Turn-Off Fall Time                 | t <sub>f</sub>      |                                                                                        | -   | 80   | -    | nS   |
| Total Gate Charge                  | Q <sub>g</sub>      | V <sub>DS</sub> =15V, I <sub>D</sub> =10A,<br>V <sub>GS</sub> =5V                      | -   | 13   | -    | nC   |
| Gate-Source Charge                 | Q <sub>gs</sub>     |                                                                                        | -   | 5.5  | -    | nC   |
| Gate-Drain Charge                  | Q <sub>gd</sub>     |                                                                                        | -   | 3.5  | -    | nC   |
| Drain-Source Diode Characteristics |                     |                                                                                        |     |      |      |      |
| Diode Forward Voltage (Note 3)     | V <sub>SD</sub>     | V <sub>GS</sub> =0V, I <sub>S</sub> =10A                                               | -   | -    | 1.2  | V    |
| Diode Forward Current (Note 2)     | I <sub>S</sub>      |                                                                                        | -   | -    | 10   | A    |

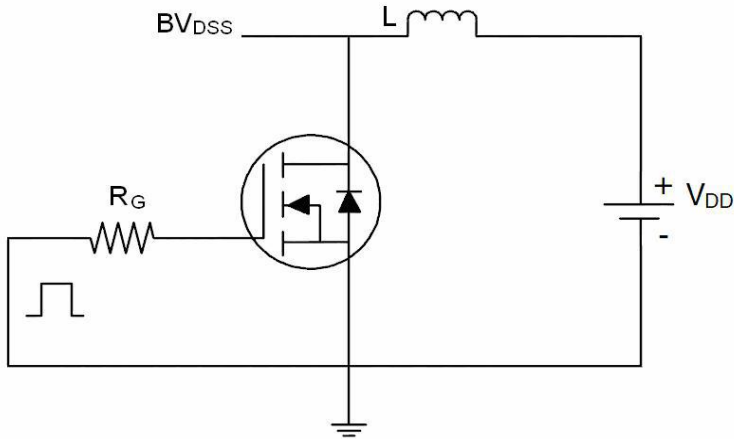
**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production

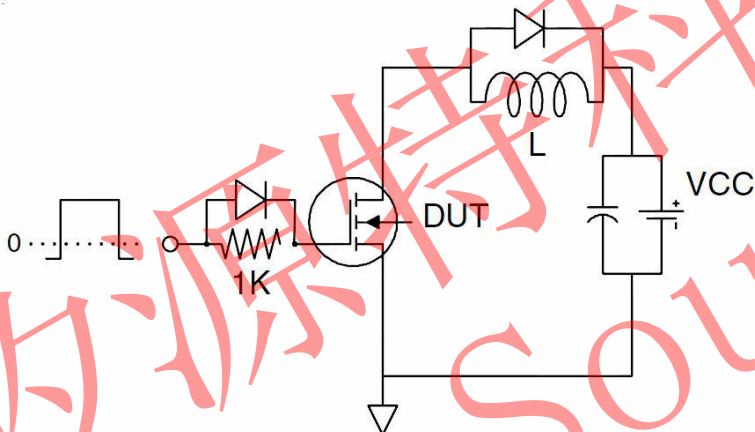


## Test Circuit

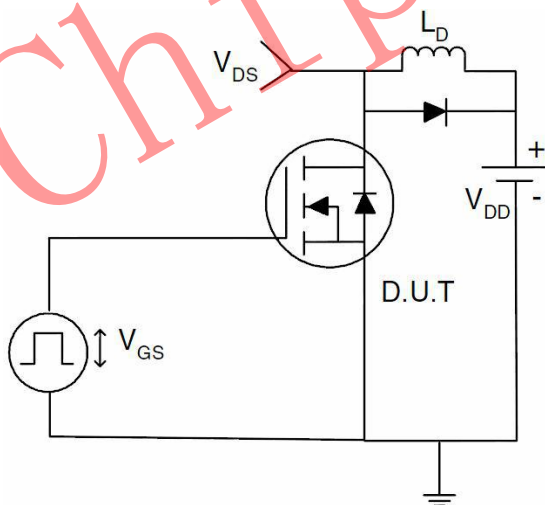
### 1) EAS Test Circuits



### 2) Gate Charge Test Circuit:



### 3) Switch Time Test Circuit:





## Typical Electrical and Thermal Characteristics (Curves)

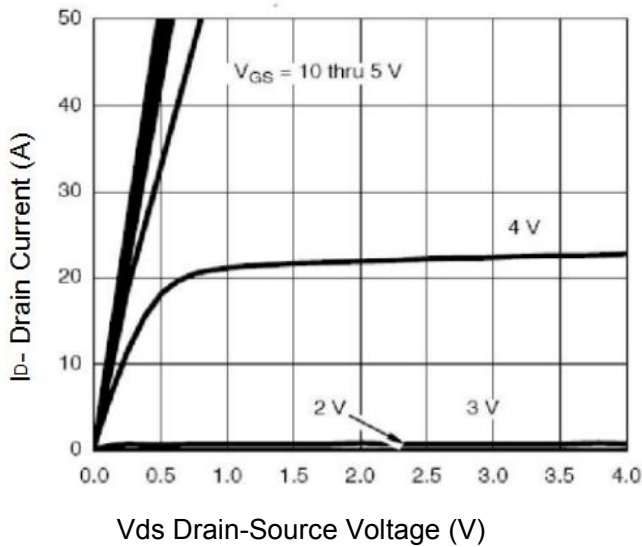


Figure 1 Output Characteristics

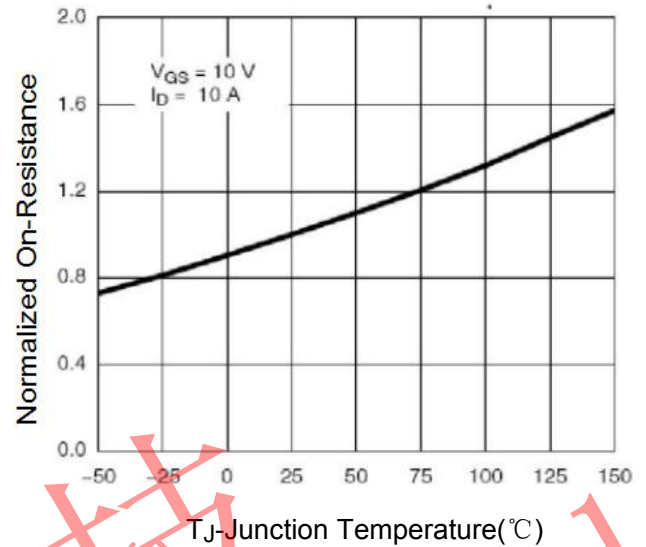


Figure 4 Rdson-Junction Temperature

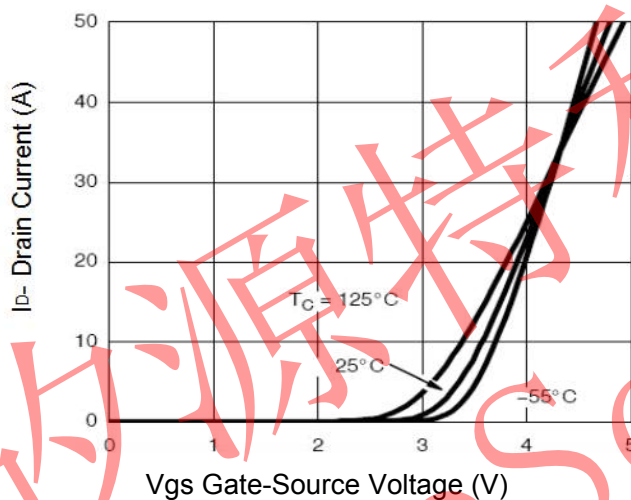


Figure 2 Transfer Characteristics

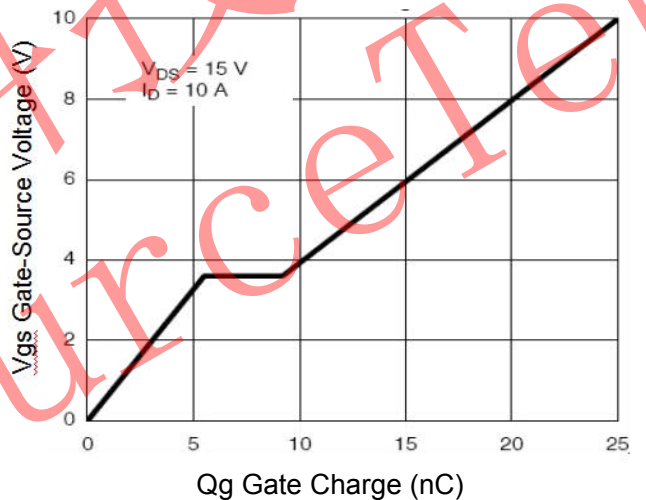
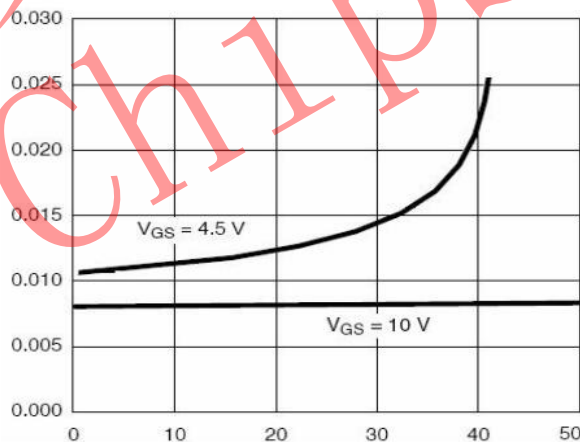
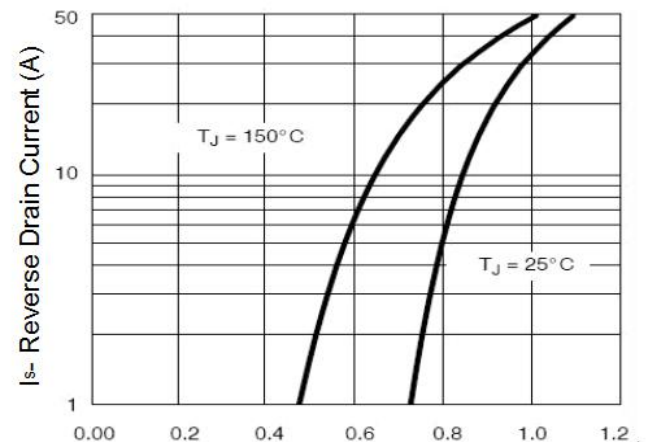


Figure 5 Gate Charge



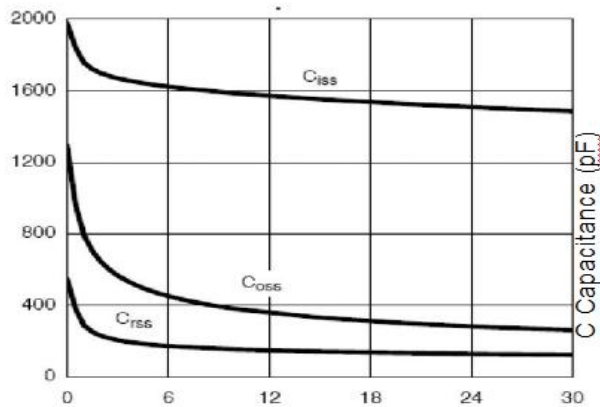
ID- Drain Current(A)

Figure 3 Rdson- Drain Current



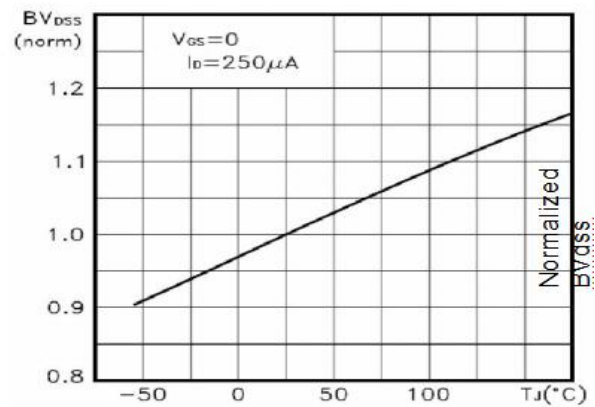
Vsd Source-Drain Voltage (v)

Figure 6 Source- Drain Diode Forward



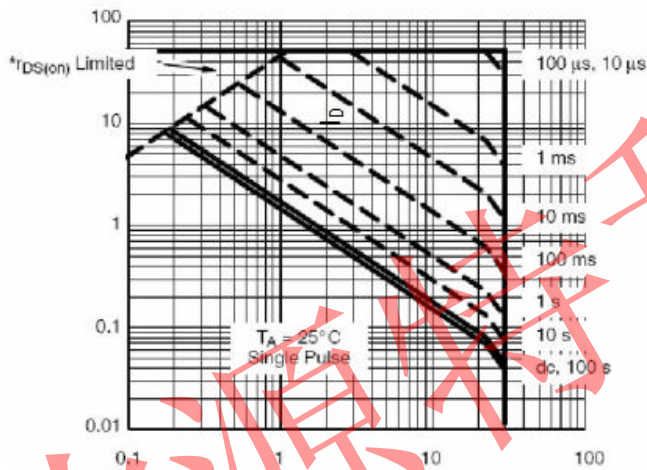
Vds Drain-Source Voltage (V)

Figure 7 Capacitance vs Vds



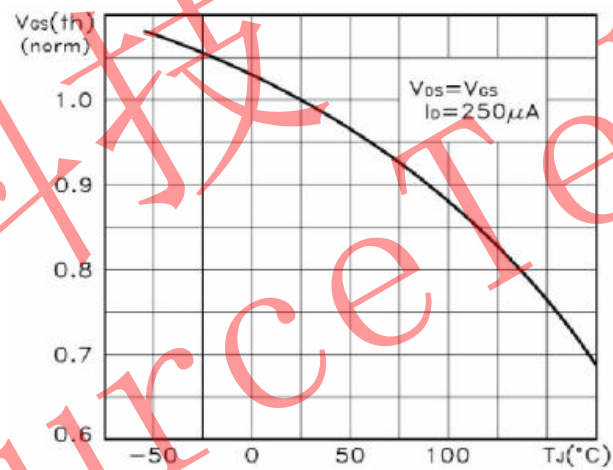
TJ-Junction Temperature(°C)

Figure 9 BVdss vs Junction Temperature



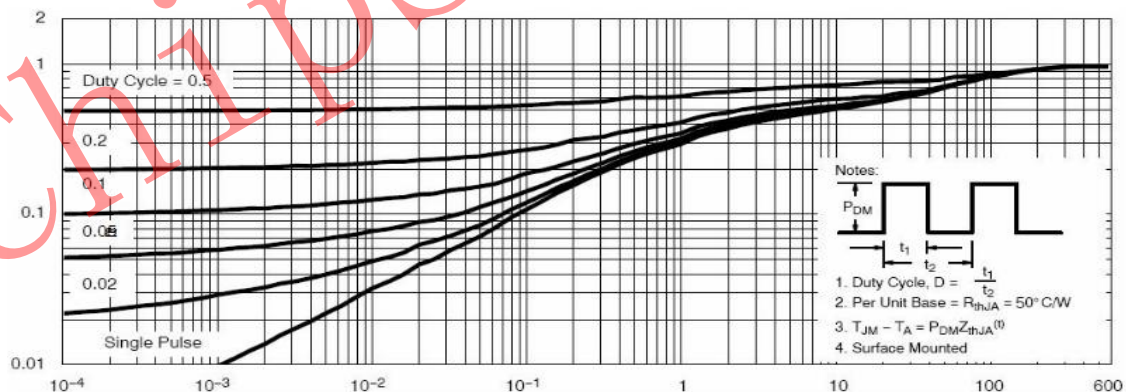
Vds Drain-Source Voltage (V)

Figure 8 Safe Operation Area



TJ-Junction Temperature(°C)

Figure 10 Vgs(th) vs Junction Temperature

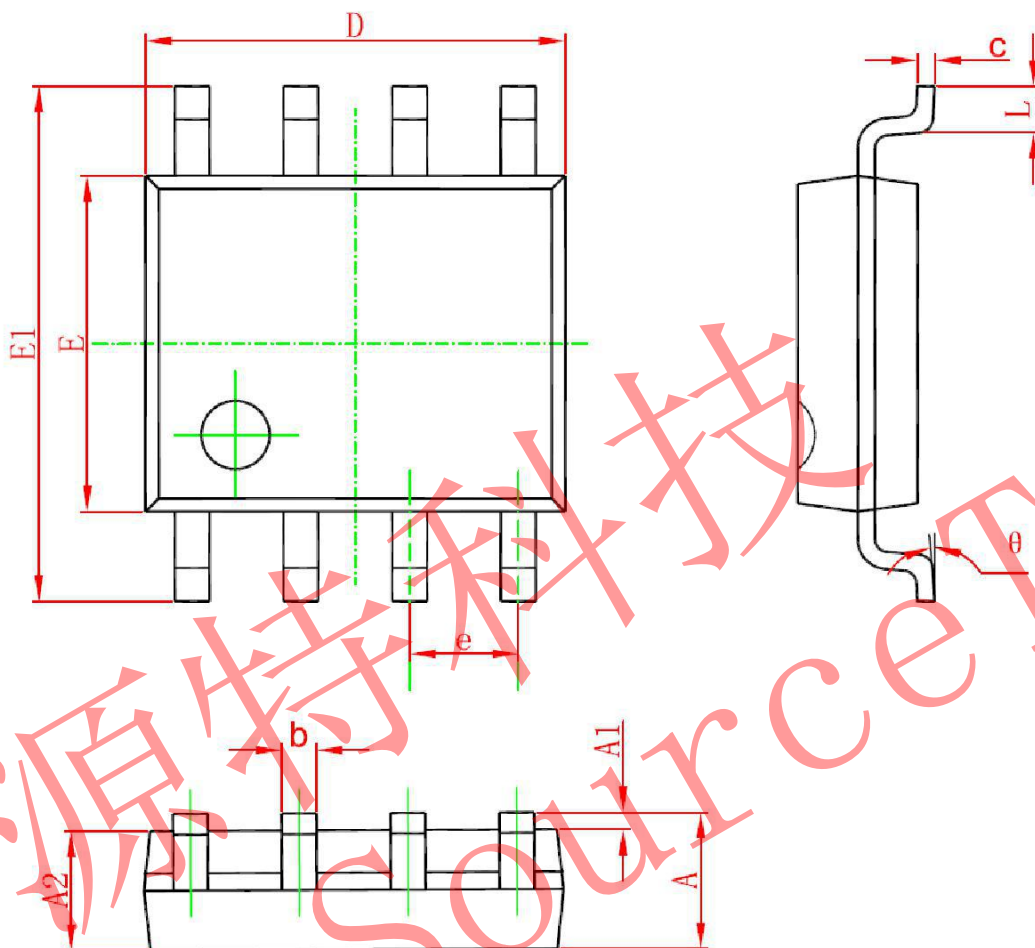


Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



SOP-8 Package Information



| Symbol   | Dimensions In Millimeters |       | Dimensions In Inches |       |
|----------|---------------------------|-------|----------------------|-------|
|          | Min                       | Max   | Min                  | Max   |
| A        | 1.350                     | 1.750 | 0.053                | 0.069 |
| A1       | 0.100                     | 0.250 | 0.004                | 0.010 |
| A2       | 1.350                     | 1.550 | 0.053                | 0.061 |
| b        | 0.330                     | 0.510 | 0.013                | 0.020 |
| c        | 0.170                     | 0.250 | 0.006                | 0.010 |
| D        | 4.700                     | 5.100 | 0.185                | 0.200 |
| E        | 3.800                     | 4.000 | 0.150                | 0.157 |
| E1       | 5.800                     | 6.200 | 0.228                | 0.244 |
| e        | 1.270 (BSC)               |       | 0.050 (BSC)          |       |
| L        | 0.400                     | 1.270 | 0.016                | 0.050 |
| $\theta$ | 0°                        | 8°    | 0°                   | 8°    |